

TO-220F N MOS

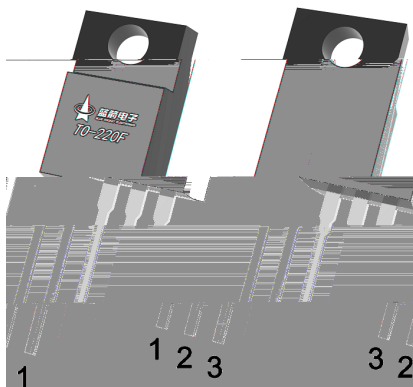
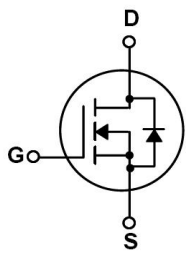
SiC N-CHANNEL MOSFET in a TO-220F Plastic Package.

$V_{DS}=650V$ $I_D=7A$

$R_{DS(on)}@15V$ 650m (Type.500m)

$R_{DS(on)}@18V$ 600m (Type. 378m)

LED driver, PD charger, PC adapter, Air-conditioning, E-bike charger.



PIN1 G

PIN 2 D

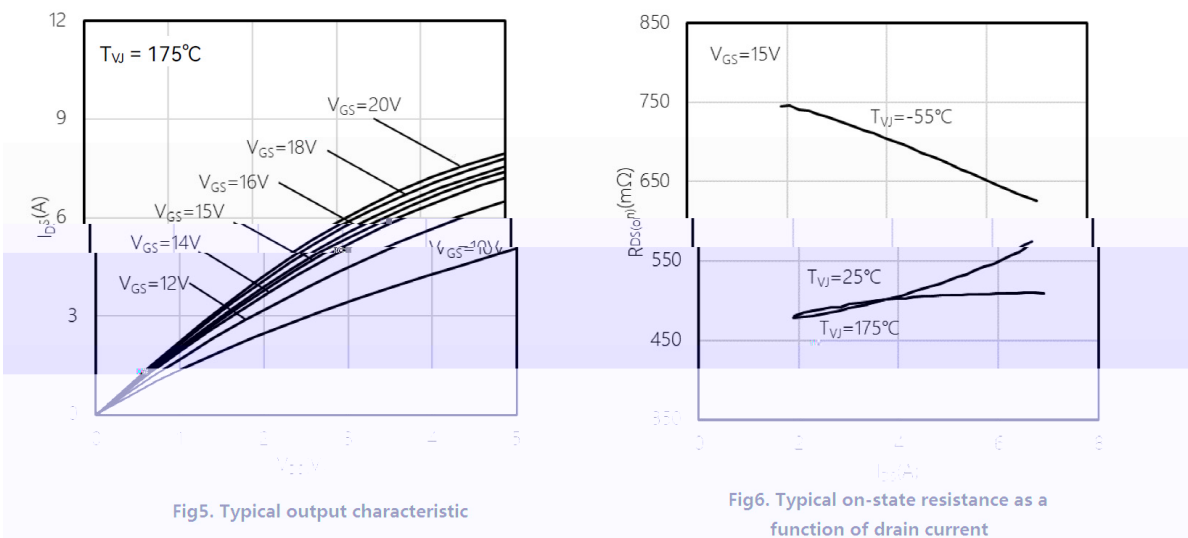
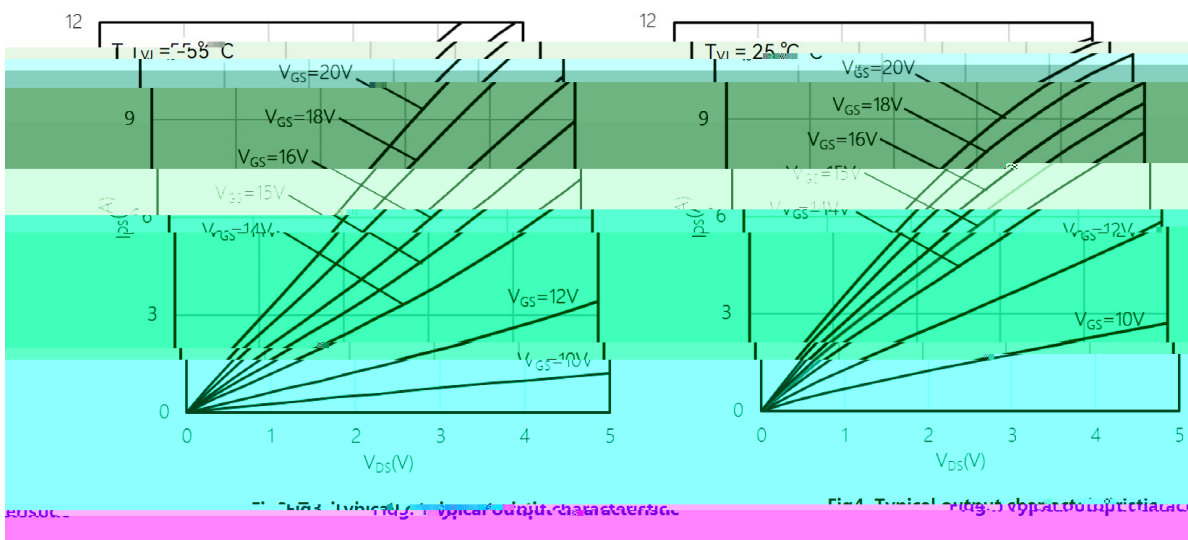
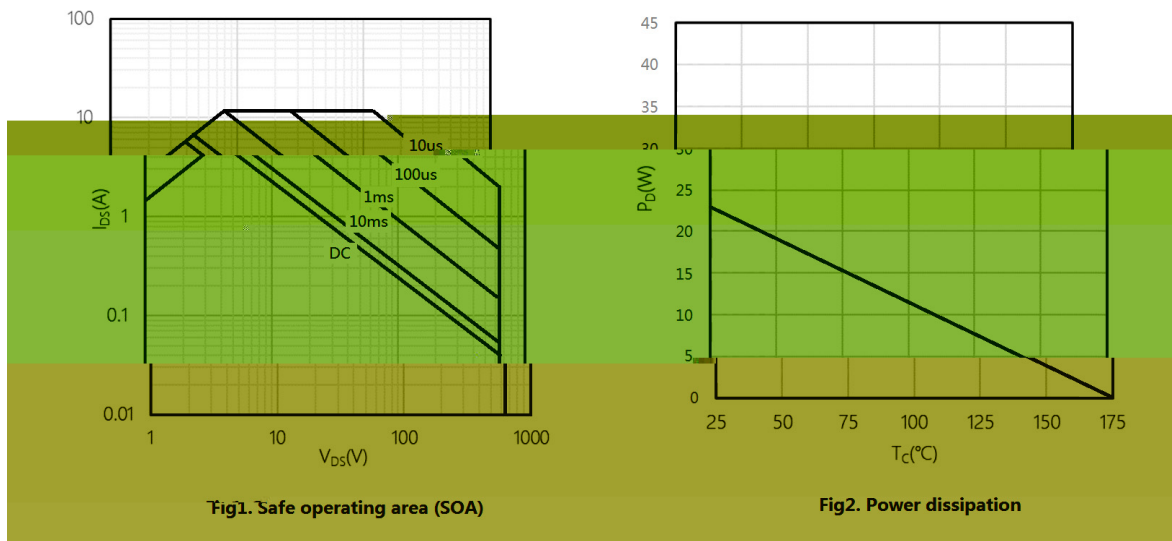
PIN 3 S

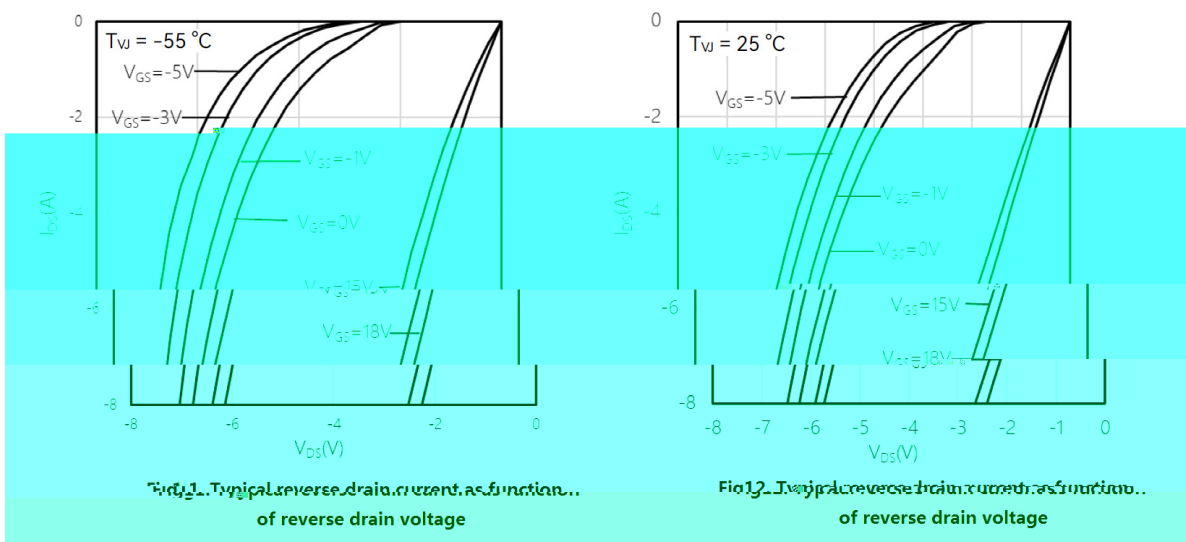
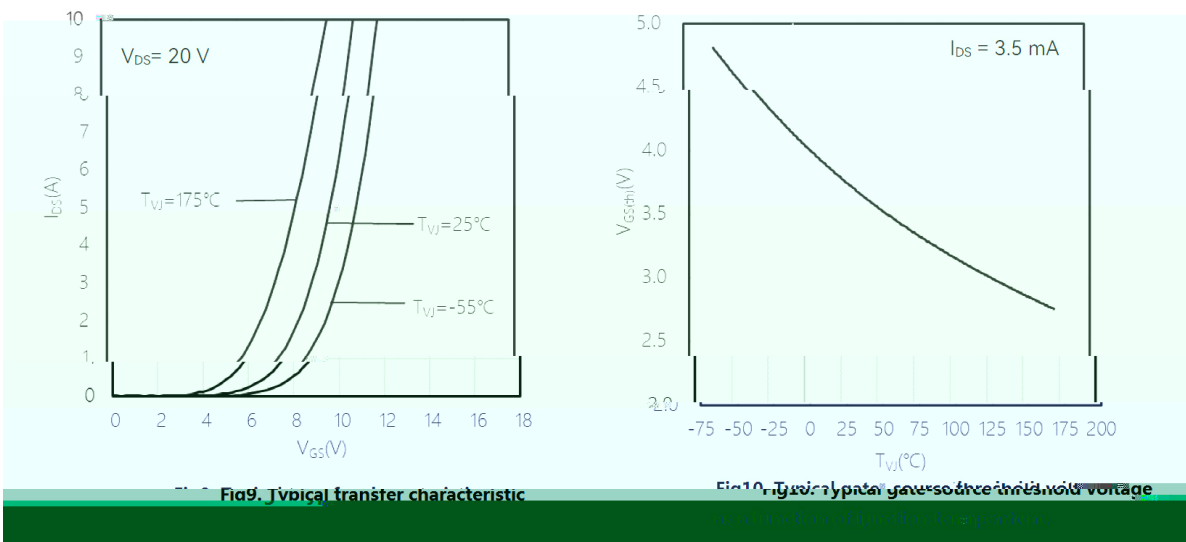
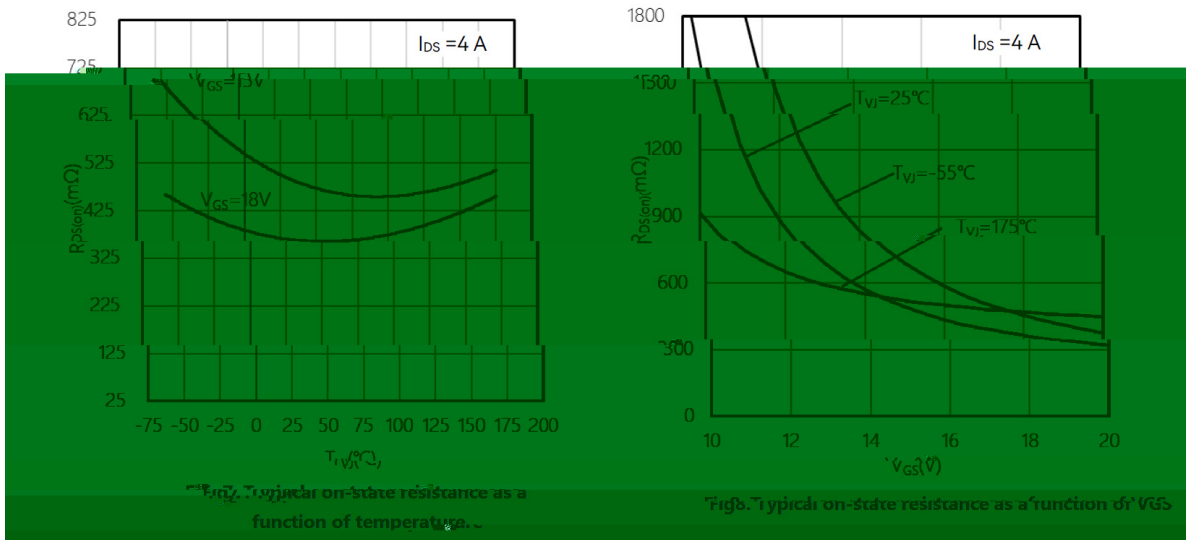
See Marking Instructions.

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	650	V
Continuous DC Drain Current for $R_{th(j-c,typ.)}$, Limited by $T_{VJ(max)}$	$I_D(T_c=25^\circ C)$	7	A
	$I_D(T_c=100^\circ C)$	5.7	A
Peak Drain Current, tp Limited by $T_{VJ(max)}$	I_{DM}	12	A
Gate-Source Max Voltage	$V_{GS,max}$	-10/+22	V
Gate-Source Operate Voltage	$V_{GS,op}$	0/+15	V
Single Pulse Avalanche Energy	E_{AS}	10.2	mJ
Power Dissipation or $R_{th(j-c,typ.)}$	$P_D(T_c=25^\circ C)$	23	W
Operating and Storage Temperature Range	T_{VJ}, T_{STG}	-55 to 175	
MOSFET/Body Diode Junction-Case Thermal Resistance	$R_{th(j-c)}$	6.52	/W

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V$ $I_D=100\text{ A}$	650			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ $I_D=3.5mA$	3		5	V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=650V$ $V_{GS}=0V$		0.1	20	A
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=22V$ $V_{DS}=0V$			250	nA
Source-Gate Leakage Current	I_{SGS}	$V_{GS}=-10V$ $V_{DS}=0V$			250	nA
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=15V$ $I_D=4A$		500	650	m
		$V_{GS}=15V$ $I_D=4A$ $T_{VJ}=175$		509		
		$V_{GS}=18V$ $I_D=4A$		378	600	
		$V_{GS}=18V$ $I_D=4A$ $T_{VJ}=175$		454		
Body Diode Forward Voltage	V_{SD}	$V_{GS}=0V$ $I_S=2A$		3.8		V
Continuous DC Source Current	I_S			6		A
Peak Reverse Drain Current	I_{SM}			12		A
Reverse Recovery Time	t_{rr}	$V_{GS} = 0V, I_{SD}=4A, V_R=400V, di/dt=1.1kA/us$		7.9		ns
Reverse Recovery Charge	Q_{rr}			20		nC
Peak Reverse Recovery Current	I_{rrm}			4.2		A
Reverse Recovery Energy	E_{rr}			0.19		J

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Turn-On Delay Time	$t_{d(on)}$	$V_{GS}=0/15V$ $L=600\ H$ $V_{DD}=400V$ $I_D=4A$ $R_g=10\ \Omega$		16.1		ns
Turn-On Rise Time	t_r			13.9		
Turn-Off Delay Time	$t_{d(off)}$			13.3		
Turn-Off Fall Time	t_f			13.7		
Turn On Switching Loss	E_{on}			41.2		J
Turn Off Switching Loss	E_{off}			3.1		
Total Switching Energy	E_{tot}			44.3		
Gate resistance	R_g	$V_{AC}=25mV$ $f=1MHz$		35		
Input Capacitance	C_{iss}	$V_{DS}=400V$ $V_{GS}=0V$ $f=1MHz$		149		pF
Output Capacitance	C_{oss}			11		
Reverse Transfer Capacitance	C_{rss}			0.8		
Total Gate Charge	Q_g	$V_{GS}=0/15V,$ $V_{DS}=400V,$ $I_D=4A$		6.7		nC
Gate Source Charge	Q_{gs}			3.0		
Gate Drain Charge	Q_{gd}			1.1		





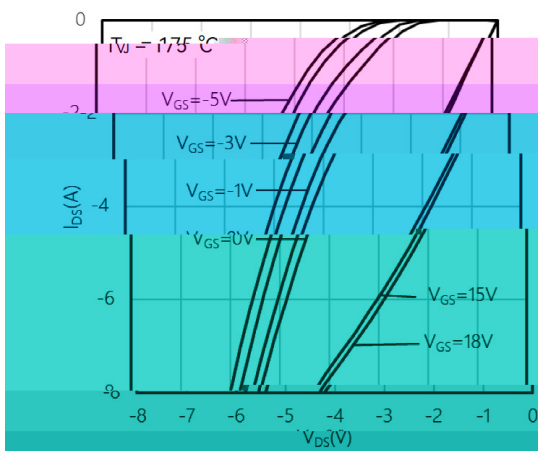


Fig13. Typical reverse drain current as a function

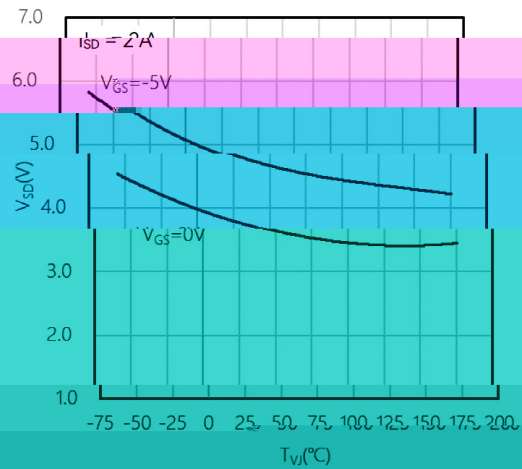


Fig14. Typical reverse drain voltage as

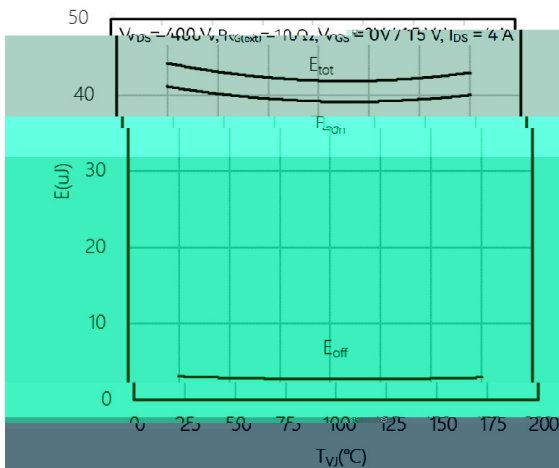


Fig15. Typical switching energy as a function of junction temperature, 2nd device own body diode: VGS = 0V

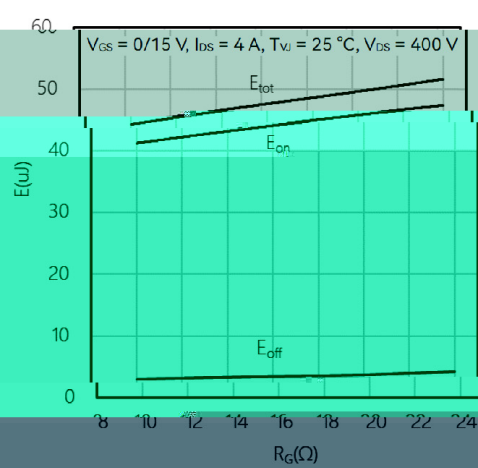


Fig16. Typical switching energy losses as a function of gate resistance, 2nd device own body diode: VGS = 0V

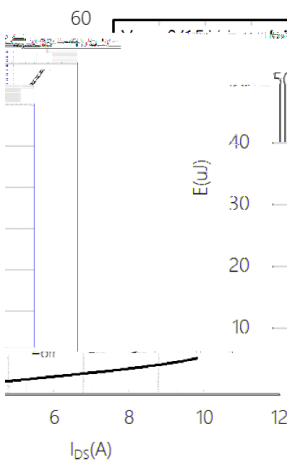


Fig17. Typical switching energy losses as a function of gate resistance, 2nd device own body diode: VGS = 0V

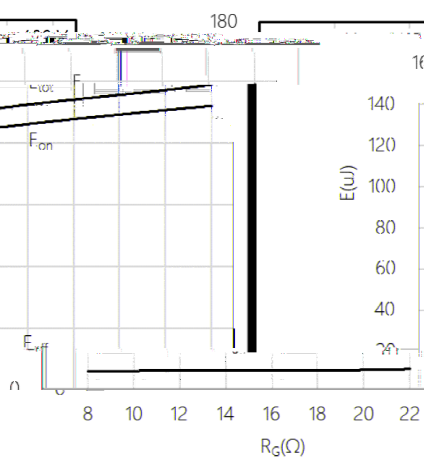


Fig18. Typical switching energy losses as a function of Ids, 2nd device own body diode: VGS = 0V

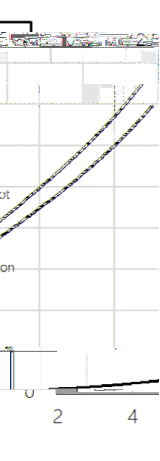


Fig19. Typical switching energy losses as a function of Ids, 2nd device own body diode: VGS = 0V

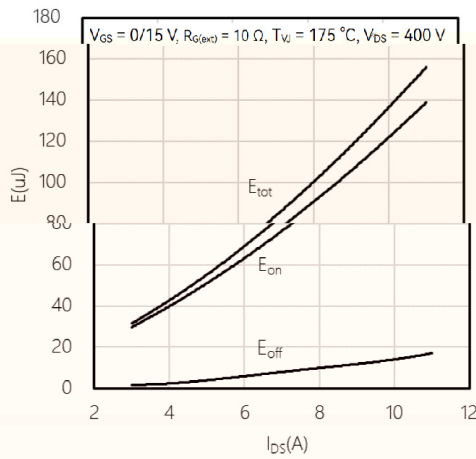
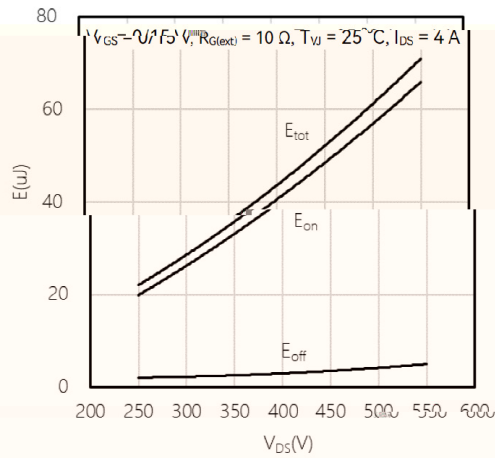
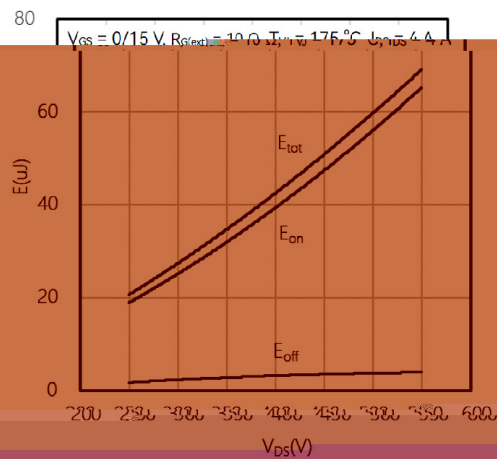
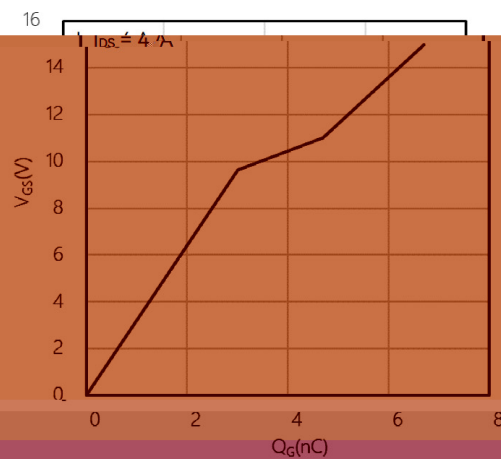
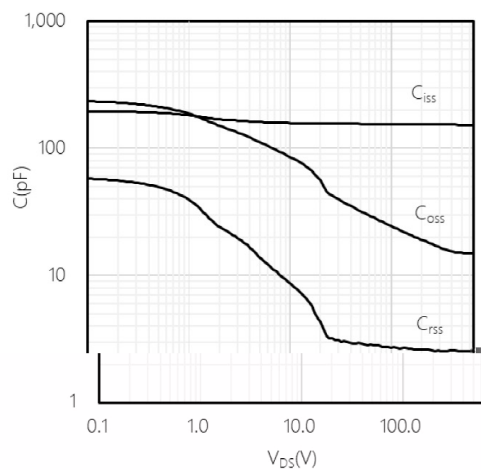

 Fig19. Typical switching energy losses as a function of I_{DS} .

 Fig20. Typical switching energy losses as a function of V_{DS} .

 Fig21. Typical switching energy losses as a function of V_{DS} .


Fig22. Typical gate charge


 Fig23. Typical capacitance as a function of V_{DS} .

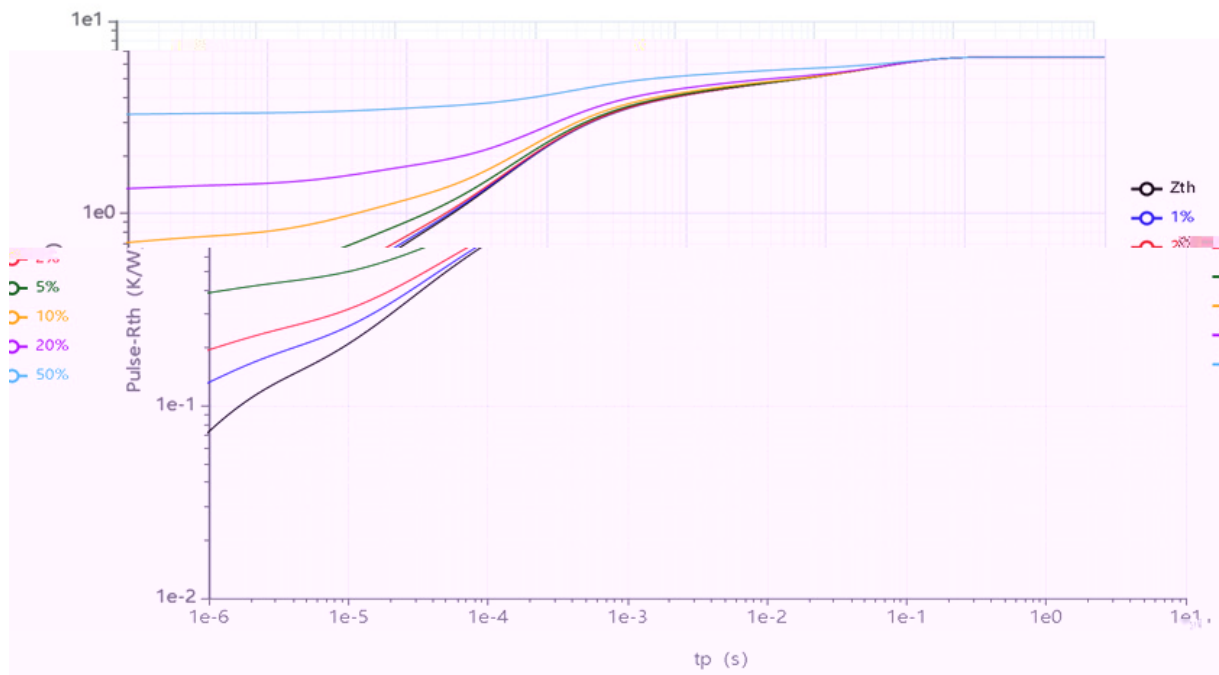
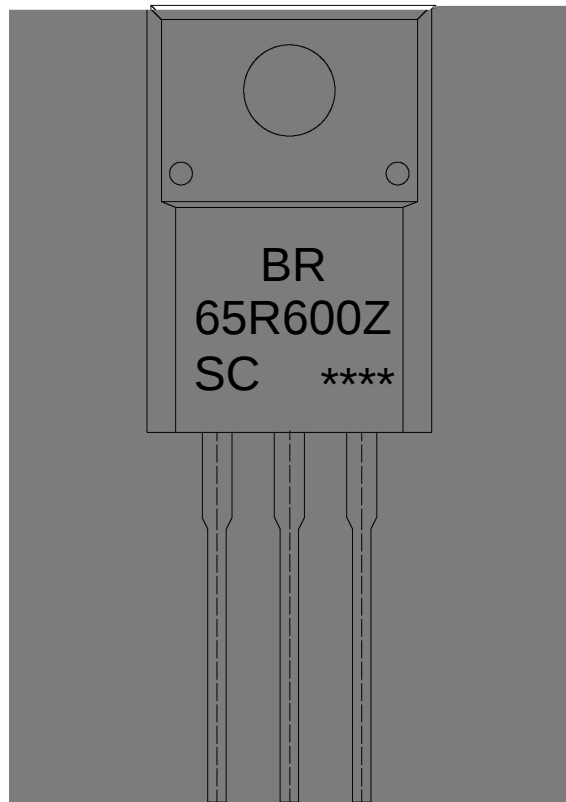


Fig24. Transient thermal resistance (MOSFET)



BR
65R600Z

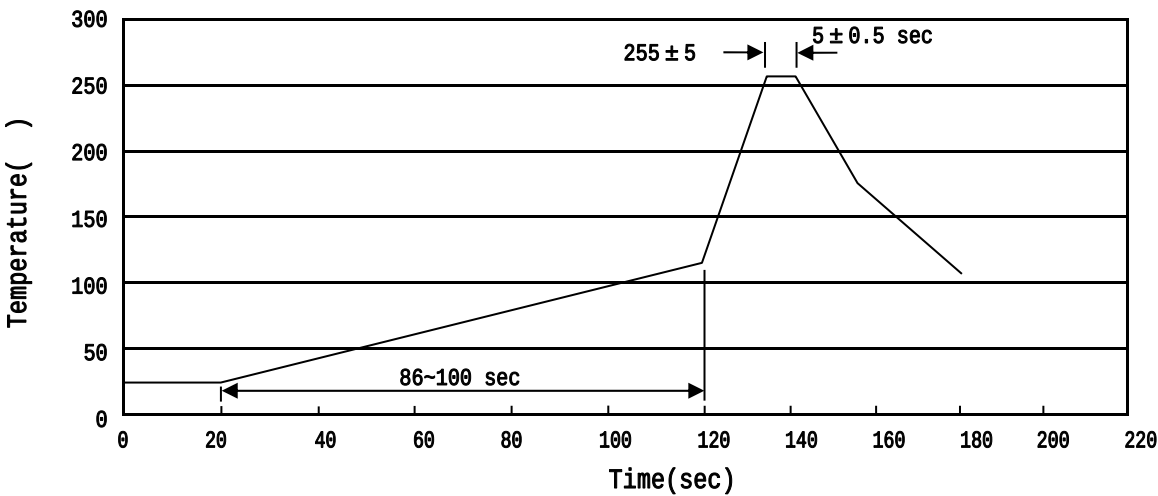
Note:

BR: Company Code

65R600Z: Product Type Code

SC: SiC

****: Lot No. Code, code change with Lot No.



Note:

- 1

25 150

60 90sec;

1.Preheating:25~150 , Time:60~90sec.
- 2

255 5

5 0.5sec;

2.Peak Temp.:255 5 , Duration:5 0.5sec.
- 3

2 10

/sec.

3. Cooling Speed: 2~10 /sec.

270 5

10 1 sec.

Temp.:270±5

Time:10±1 sec

/ BULK

Package Type	Units					Dimension (unit mm ³)		
	Units/Bag /	Bags/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Bag	Inner Box	Outer Box
TO-220/F	200	10	2,000	5	10,000	135×190	237×172×102	560×245×195

/ TUBE

Package Type	Units					Dimension (unit mm ³)		
	Units/Tube /	Tubes/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Tube	Inner Box	Outer Box
TO-220/F	50	20	1,000	5	5,000	532×31.4×5.5	555×164×50	575×290×180

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